2SC5440

Silicon NPN triple diffusion mesa type

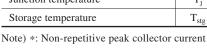
For horizontal deflection output

■ Features

- High breakdown voltage, and high reliability through the use of a glass passivation layer
- High-speed switching
- Wide safe operation area (ASO)

■ Absolute Maximum Ratings $T_C = 25$ °C

Parameter	Symbol	Rating	Unit	
Collector-base voltage (En	V _{CBO}	1500	V	
Collector-emitter voltage (E-B short)		V _{CES}	1 500	V
Collector-emitter voltage	V _{CEO}	600	V	
Emitter-base voltage (Collector open)		V _{EBO}	7	V
Base current		I_B	7.5	A
Collector current		I_{C}	15	A
Peak collector current *		I_{CP}	25	A
Collector power dissipation		P_{C}	60	W
	$T_a = 25^{\circ}C$		3.0	
Junction temperature		T _j	150	°C
Storage temperature		T_{stg}	-55 to +150	°C



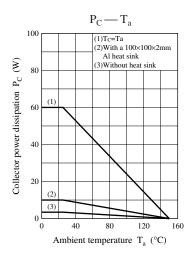
Unit: mm 3.0±0.3 2: Collector 3: Emitter EIAJ: SC-94 TOP-3E-A1 Package

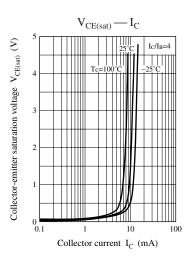
■ Electrical Characteristics $T_C = 25$ ° $C \pm 3$ °C

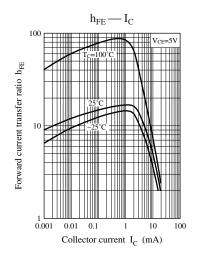
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base cutoff current (Emitter open)	I_{CBO}	$V_{CB} = 1000 \text{ V}, I_E = 0$			50	μΑ
		$V_{CB} = 1500 \text{ V}, I_E = 0$			1	mA
Emitter-base cutoff current (Collector open)	I_{EBO}	$V_{EB} = 7 \text{ V}, I_{C} = 0$			50	μΑ
Forward current transfer ratio	h_{FE}	$V_{CE} = 5 \text{ V}, I_{C} = 7.5 \text{ A}$	5		9	_
Collector-emitter saturation voltage	V _{CE(sat)}	$I_C = 7.5 \text{ A}, I_B = 1.88 \text{ A}$			3	V
Base-emitter saturation voltage	V _{BE(sat)}	$I_C = 7.5 \text{ A}, I_B = 1.88 \text{ A}$			1.5	V
Transition frequency	f_T	$V_{CE} = 10 \text{ V}, I_{C} = 0.1 \text{ A}, f = 0.5 \text{ MHz}$		3		MHz
Storage time	t _{stg}	$I_C = 7.5 \text{ A}$, Resistance loaded			2.7	μs
Fall time	t _f	$I_{B1} = 1.88 \text{ A}, I_{B2} = -3.76 \text{ A}$			0.2	μs

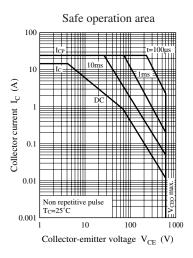
Note) Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

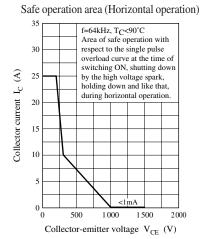
2SC5440 Panasonic











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